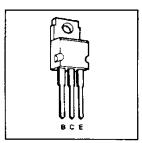
TIP120,TIP121,TIP122 **NPN DARLINGTON - CONNECTED** SILICON POWER TRANSISTORS

SLPS054 Revised March 1990

- Designed for Complementary Use with TIP125, TIP126 and TIP127
- 65 W at 25°C Case Temperature
- **5 A Continuous Collector Current**
- Min hee of 1000 at 3 V, 3 A
- Designed for Ignition Systems, Motor Control and Solenoid **Driver Applications**



PACKAGE: TO220

Absolute Maximum Ratings at 25°C Case Temperature (unless otherwise noted)

		TIP120	TIP121	TIP122		
Vceo	Collector - base voltage (IE = 0)	60 V	80 V	100 V		
VCEO	Collector - emitter voltage (I _B =0)	60 V	100 V			
VEBO	Base - emitter voltage		5 V			
lç	Continuous collector current	5 A				
Ісм	Peak collector current (Note 1)	8 A				
le	Continuous base current	0.1 A				
Ptot	Continuous device dissipation at (or below) 25°C case temperature (Note 2)	65 W				
P _{tot}	Continuous device dissipation at (or below) 25°C free - air temperature (Note 3)	2 W				
lc ² L/2	Unclamped inductive load energy (Note 4)	50 mJ				
T _i & T _{stg}	Operating junction and storage temperature range	-65°C to + 150°C				
T∟	Lead temperature 3.2 mm from case for 10 seconds	260°C				

- NOTES 1 This value applies for t_w ≤ 0.3 ms, duty cycle ≤ 10% 2 Derate linearly to 150°C case temperature at the rate of 0.52 W.°C 3 Derate linearly to 150°C rise, air temperature at the rate of 15mW°C 4 This rating is besed on the capability of the transistors to operate safety in a circuit of: L = 20 mH, Resz = 100 Ω, Vasz = 0 V, R₆ = 0.1 Ω, V_{CC} 20 V. Energy × t_C²-2

Electrical Characteristics at 25°C Case Temperature (unless otherwise noted)

PARAMETER		TE	TEST CONDITIONS		MIN	TYP	MAX	TINU
V(BR)CEO	Collector - emitter sustaining voltage	I _C = 30 mA (Note 5)	I _B = 0	TIP120 TIP121 TIP122	60 80 100			· · · · · · · · · · · · · · · · · · ·
ICEO	Collector - emitter .cut - off current	VCE = 30 V VCE = 40 V VCE = 50 V	IB = 0	TIP120 TIP121 TIP122			0.5 0.5 0.5	. mA :
Ісво		V _{CB} = 60 V V _{CB} = 80 V V _{CB} = 100 V	IE = 0 IE = 0 IE = 0	TIP120 TIP121 TIP122		!	0.2 0.2 0.2	mA
1 _{EBO}	Emitter out - off current	V _{EB} = 5 V	Ic = 0				2	mA
hre	Forward current transfer ratio	Vce = 3 V Vce = 3 V	I _C = 0.5 A I _C = 3 A	(Notes 5 & 6)	1000 1000			
VCE(sat)	Collector - emitter saturation voltage		Ic = 3 A IC = 5 A	(Notes 5 & 6)			2 4	v
VBE	Base - emitter volt- age	V _{CE} = 3 V	Ic = 3 A	(Notes 5 & 6)			2.5	v
VF	Parallel diode forward voltage	IF = -IC = 5 A	iB = 0	(Notes 5 & 6)			3.5	V



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Thermal Characteristics

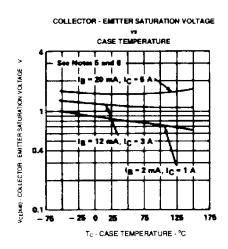
	PARAMETER	MIN	TYP	MAX	UNIT
Resc	Junction - to - case thermal resistance			1.92	°C/W
Reja	Junction - to - free - air thermal resistance			62.5	°C/W

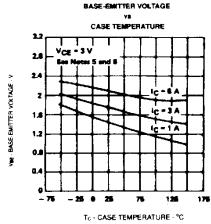
Resistive - Load - Switching Characteristics at 25°C Case Temperature (unless otherwise noted)

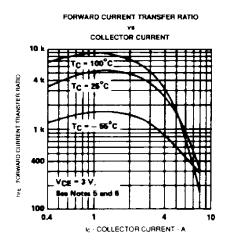
	PARAMETER		TEST CONDITION	ns [†]	MIN TYP MAX			
ton	Turn on time	Ic = 3 A	I _{B(on)} = 12 mA	I _{B(off)} = -12 mA	[15		μ5
ton	Turn off time	VBE(off) = -5 V	$R_L = 10 \Omega$			8.5		μs

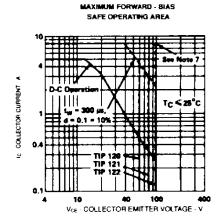
¹ Voltage and current values shown are nominal, exact values vary slightly with transistor parameters. NOTES 5: These parameters must be measured using pulse techniques. L. = 300µs, duty cycle = 2%

TYPICAL CHARACTERISTICS









NOTE: 7 This combination of maximum voltage and current may be achieved only when switching from saturation to cutoff with a clamped inductive load.



^{6.} These parameters must be measured using voltage sensing contacts separate from the current - carrying contacts

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